



#### SINGLE-CHANNEL SMART LOAD SWITCH

## **Description**

The DML3010ALFDS load switch provides a component and areareducing solution for efficient power domain switching. In addition to integrated control functionality with ultra-low on-resistance, this device offers system safeguards and monitoring via fault protection and power-good signaling. This cost-effective solution is ideal for powermanagement and hot-swap applications requiring low power consumption in a small footprint.

# **Applications**

- Portable electronics and systems
- Notebook and tablet computers
- Telecom, networking, medical, and industrial equipment
- Set-top boxes, servers, and gateways
- Hot-swap devices and peripheral ports

## **Features and Benefits**

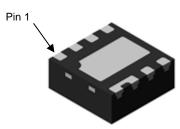
- Advanced Controller with Charge Pump
- Integrated N-Channel MOSFET with Ultra-Low ROM
- Input-Voltage Range 0.5V to 20V
- Power-Good Signal
- Thermal Shutdown
- Vcc Undervoltage Lockout
- Short-Circuit Protection
- Extremely Low Standby Current
- Load Bleed (Quick Discharge)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Package: V-DFN2020-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.011 grams (Approximate)

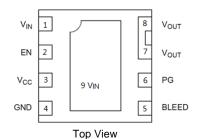


Top View



**Bottom View** 

V-DFN2020-8 (Type N)



## **Ordering Information** (Note 4)

Part Number	Paakaga	Packing		
Part Number	Package	Qty.	Carrier	
DML3010ALFDS-7	V-DFN2020-8 (Type N)	3000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**

Site 1

V-DFN2020-8 (Type N)



LS30A = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 24 = 2024) WW = Week Code (01 to 53)

Site 2

V-DFN2020-8 (Type N)

¥ ES30A

LS30A = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 4 = 2024) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

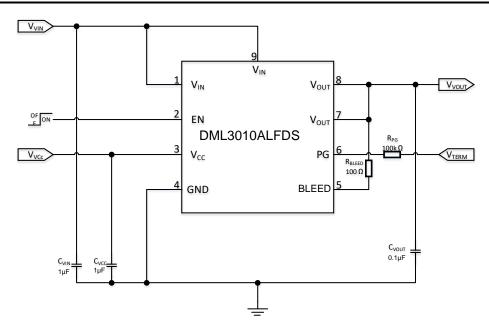
Date Code Key

Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	3	4	5	6	7	8	9	0	1	2	3	4

Week	1-26	27-52	53
Code	A-Z	a-z	Z

	Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
ĺ	Code	Т	U	V	W	X	Υ	Z

# **Typical Application Circuit**

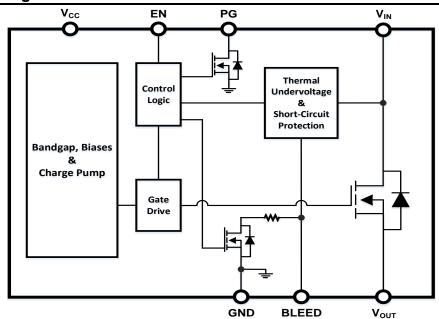




# **Pin Description**

Pin Number	Pin Name	Pin Function
1, 9	V <sub>IN</sub>	Drain of internal MOSFET, pin 1 must connect to pin 9
2	EN	Active-high digital input used to turn on the MOSFET; pin has an internal pulldown resistor to GND
3	Vcc	Supply voltage to controller (3.0V to 5.5V)
4	GND	Controller ground
5	BLEED	Load bleed connection, must be tied to V <sub>OUT</sub> through a resistor ≤ 1kΩ
6	PG	Active-high, open-drain output that indicates when the gate of the MOSFET is fully charged, external pullup resistor ≥ 1kΩ to an external voltage source required; tie to GND if not used.
7, 8	Vout	Source of internal MOSFET connected to load

# **Function Block Diagram**





# **Absolute Maximum Rating**

Parameter	Rating
VIN, BLEED, VOUT to GND	-0.3V to 24V
EN, V <sub>CC</sub> , PG to GND	-0.3V to 6V
IMAX_DC	10.5A
Storage Temperature (Ts)	-65°C to +150°C

# **Recommended Operating Ranges**

Parameter	Rating
Supply Voltage (V <sub>CC</sub> )	3V to 5.5V
Input Voltage (V <sub>IN</sub> )	0.5V to 20V
Ambient Temperature (T <sub>A</sub> )	-40°C to +85°C
Junction Temperature (T <sub>J</sub> )	-40°C to +125°C
Package Thermal Resistance (θ <sub>JC</sub> )	5.3°C/W
Package Thermal Resistance (θJA)	40°C/W

<sup>\*</sup>I<sub>MAX\_DC</sub> defined as the maximum steady-state current the load switch can pass at room ambient temperature without entering thermal lockout.

**Electrical Characeristics** ( $T_A = +25$ °C,  $V_{VCC} = 3.3V$ ,  $V_{VIN} = 5V = V_{TERM}$ ,  $C_{VIN} = 1\mu F$ ,  $C_{VOUT} = 0.1\mu F$ ,  $C_{VCC} = 1\mu F$ ,  $C_{SR} = 1n F$ , unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>IN</sub>	Input Voltage	_	0.5	_	20	V
Vcc	Supply Voltage	_	3.0	_	5.5	V
	V 5	V <sub>EN</sub> = V <sub>CC</sub> = 3V, V <sub>IN</sub> = 20V	_	150	290	μΑ
IDYN	Vcc Dynamic Supply Current	VEN = VCC = 5.5V, VIN = 1.8V	_	200	390	μΑ
		Vcc = 3V, Ven = 0	_	0.1	1	μΑ
ISTBY	Vcc Shutdown Supply Current	Vcc = 5.5V, Ven = 0	_	0.1	2	μA
VENH	EN High-Level Voltage	Vcc = 3V to 5.5V	2.0	_	_	V
VENL	EN Low-Level Voltage	Vcc = 3V to 5.5V	_	_	0.8	V
_	BL 18 ::	Vcc = 3V, Ven = 0	90	120	180	Ω
RBLEED	Bleed Resistance	Vcc = 5.5V, VEN = 0	70	100	130	Ω
	5	Vcc = Ven = 3V, Vin = 1.8V	_	3	_	μA
I <sub>BLEED</sub>	Bleed Pin Leakage Current	Vcc = Ven = 3V, Vin = 20V	_	32	_	μA
Vpgl	PG Output Low Voltage	Vcc = 3V, Isink = 5mA	_	_	0.2	V
lpg	PG Output Leakage Current	Vcc = 3V, Vterm = 3.3V	_	_	100	nA
Switching D	Device			I .	I .	l
		Vcc = 3.3V, V <sub>IN</sub> = 1.8V	_	10	12.5	mΩ
		Vcc = 3.3V, Vin = 5V	_	10	12.5	mΩ
Ron	Switch On-State Resistance	$V_{CC} = 3.3V, V_{IN} = 12V$	_	10	12.5	mΩ
KON		$V_{CC} = 5V, V_{IN} = 1.8V$	_	7.5	10.5	mΩ
		$V_{CC} = 5V$ , $V_{IN} = 5V$	_	7.5	10.5	mΩ
		Vcc = 5V, Vin = 12V	_	7.5	10.5	mΩ
ILEAK	Input Shutdown Supply Current	$V_{EN} = 0$ , $V_{IN} = 20V$	_	_	10	μΑ
RPDEN	EN Pulldown Resistance	_	70	100	130	kΩ
Fault Protect	ction	•				
Тотр	Thermal Shutdown Threshold	Vcc = 3V to 5.5V	_	+145	_	°C
Totphys	Thermal Shutdown Hysteresis	Vcc = 3V to 5.5V	_	+20	_	°C
Vuvlo	Vcc Lockout Threshold	_	2.3	2.55	2.8	V
Vuvlohys	Vcc Lockout Hysteresis	_	_	200	_	mV
		$V_{CC} = 3.3V, V_{IN} = 0.5V$	140	240	350	mV
V <sub>SCP</sub>	Short-Circuit Protection Threshold	V <sub>CC</sub> = 3.3V, V <sub>IN</sub> = 1.2V to 12V	120	240	500	mV
		Vcc = 3.3V, V <sub>IN</sub> = 20V	100	250	500	mV



Switching Characeristics (TA = +25°C, VTERM = VVCC = 5V, RPG =  $100k\Omega$ , RVOUT =  $10\Omega$ , CVIN =  $1\mu$ F, CVOUT =  $0.1\mu$ F, CVCC =  $1\mu$ F, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Тур	Max	Unit	
V <sub>IN</sub> = 1.8V							
4	Output Turn On Dalay Time	Vcc = 3.3V	100	350	600		
ton	Output Turn-On Delay Time	Vcc = 5V	60	220	400		
	Outrout Town Off Dalay Times	Vcc = 3.3V	_	1	2	μs	
toff	Output Turn-Off Delay Time	Vcc = 5V	_	1	2		
	Davis Cood Time On Time	Vcc = 3.3V	0.3	0.65	1		
tpgon	Power-Good Turn-On Time	Vcc = 5V	0.3	0.55	1	ms	
	Davies Coad Time Of Time	Vcc = 3.3V	_	20	100		
tpgoff	Power-Good Turn-Off Time	Vcc = 5V	_	15	100	ns	
0.0	0 / /0   0 /	V <sub>CC</sub> = 3.3V	1	10	20	kV/s	
SR	Output Slew Rate	Vcc = 5V	1	10	20		
V <sub>IN</sub> = 12V		•		•	•	•	
	Outrout Town On Dalay Times	V <sub>CC</sub> = 3.3V	100	300	600		
ton	Output Turn-On Delay Time	Vcc = 5V	60	170	400		
	Outside Town Off Balance Time	V <sub>CC</sub> = 3.3V	_	1	2	μs	
toff	Output Turn-Off Delay Time	Vcc = 5V	_	1	2		
	Davis Cood Time On Time	V <sub>CC</sub> = 3.3V	0.4	0.9	1.6		
tpgon	Power-Good Turn-On Time	Vcc = 5V	0.4	0.9	1.6	ms	
	Davies Coad Time Of Time	Vcc = 3.3V	_	20	100		
tpgoff	Power-Good Turn-Off Time	Vcc = 5V	_	15	100	ns	
OD	Outrat Olava Bata	Vcc = 3.3V	5	20	40	1.777-	
SR	Output Slew Rate	V <sub>CC</sub> = 5V	5	20	40	kV/s	

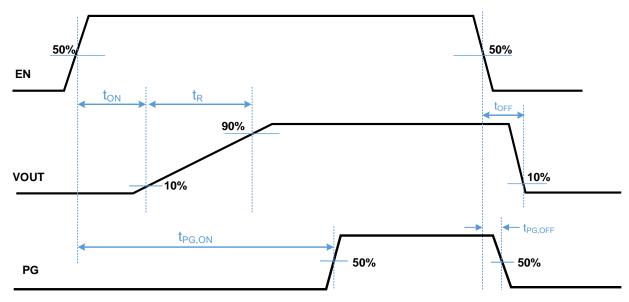
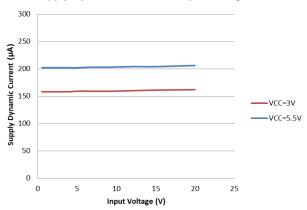


Figure 1 Timing Diagram

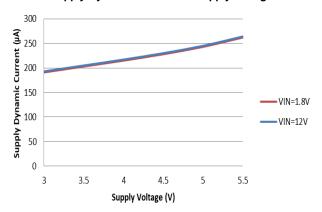


# Performance Characteristics (@TA = +25°C, unless otherwise specified.)

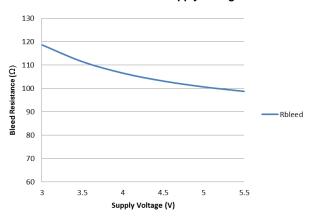




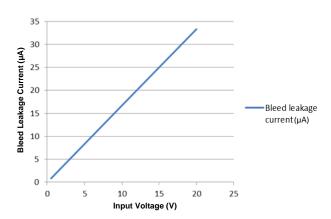
### Supply Dynamic Current vs. Supply Voltage



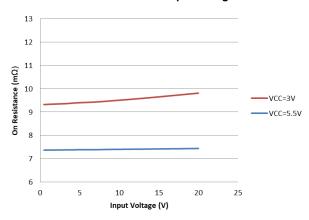
### Bleed Resistance vs. Supply Voltage



#### Bleed Leakage Current vs. Input Voltage



### ON Resistance vs. Input Voltage

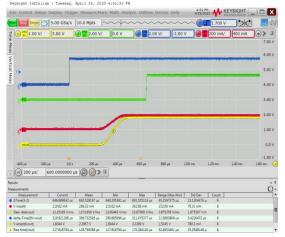




## Performance Characteristics (@TA = +25°C, unless otherwise specified.) (continued)

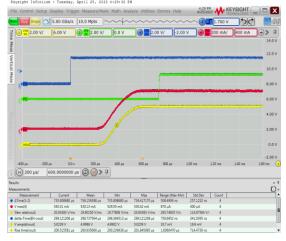
#### **Turn ON Response**

 $V_{VIN} = 1.8V$ ,  $V_{VCC} = 3.3V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



#### **Turn ON Response**

 $V_{VIN} = 5V$ ,  $V_{VCC} = 3.3V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



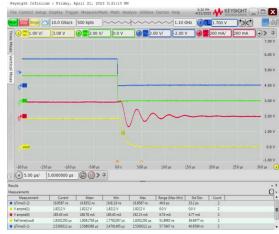
## **Turn ON Response**

 $V_{VIN} = 12V$ ,  $V_{VCC} = 3.3V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



#### **Turn OFF Response**

 $V_{VIN} = 1.8V$ ,  $V_{VCC} = 3.3V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



#### **Turn OFF Response**

 $V_{VIN} = 5V$ ,  $V_{VCC} = 3.3V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



## Turn OFF Response

 $V_{VIN}$  = 12V,  $V_{VCC}$  = 3.3V,  $V_{EN}$  = 0 to 3.3V,  $R_L$  =  $10\Omega$ 

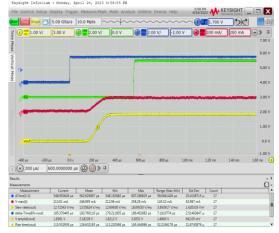




## Performance Characteristics (@TA = +25°C, unless otherwise specified.) (continued)

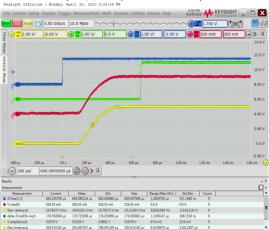
## **Turn ON Response**

 $V_{VIN} = 1.8V$ ,  $V_{VCC} = 5V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



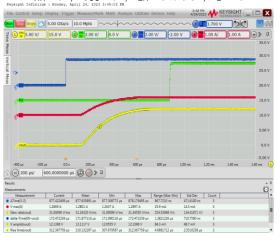
### **Turn ON Response**

 $V_{VIN}$  = 5V,  $V_{VCC}$  = 5V,  $V_{EN}$  = 0 to 3.3V,  $R_L$  =  $10\Omega$ 



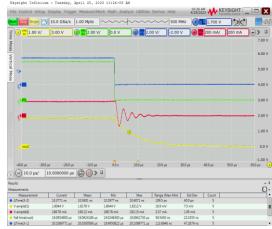
## **Turn ON Response**

 $V_{VIN} = 5V$ ,  $V_{VCC} = 5V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



## **Turn OFF Response**

 $V_{VIN} = 1.8V$ ,  $V_{VCC} = 5V$ ,  $V_{EN} = 0$  to 3.3V,  $R_L = 10\Omega$ 



### **Turn OFF Response**

 $V_{VIN}$  = 5V,  $V_{VCC}$  = 5V,  $V_{EN}$  = 0 to 3.3V,  $R_L$  =  $10\Omega$ 



## **Turn OFF Response**

 $V_{VIN}$  = 5V,  $V_{VCC}$  = 5V,  $V_{EN}$  = 0 to 3.3V,  $R_L$  =  $10\Omega$ 





# **Application Information**

#### **General Description**

The DML3010ALFDS is a single-channel load switch which integrates PG indicator in an 8-pin V-DFN2020-8 (Type N) package. The device contains an N-channel MOSFET that can operate over an input-voltage range of 0.5V to 20V and can support a maximum continuous current of 10.5A. The wide input-voltage range and high-current capability enable the device which can be used across multiple designs and end equipment.  $10m\Omega$  on-resistance minimizes the voltage drop across the load switch and power loss from the load switch.

Integrated PG indicator notifies the system about the status of the load switch to facilitate seamless power sequencing. During shutdown, the device has very low leakage current, thereby reducing unnecessary leakages for downstream modules during standby. The DML3010ALFDS also has a  $100\Omega$  on-chip resistor embedded on BLEED pin for quick discharge of the output when switch is disabled.

#### **Enable Control**

The DML3010ALFDS device allows for enabling the MOSFET in an active-high configuration. When the Vcc supply pin has an adequate voltage applied and the EN pin is at logic-high level, the MOSFET will be enabled. Similarly, when the EN pin is at logic-low level, the MOSFET will be disabled. An internal pulldown resistor to ground on the EN pin ensures that the MOSFET will be disabled when not being driven.

#### **Power Sequencing**

The DML3010ALFDS device functions with fixed power sequence. The performance of output turn-on delay may vary from what is specified. To achieve the specified performance, recommended power sequences are:

- 1.)  $V_{CC} \rightarrow V_{IN} \rightarrow V_{EN}$
- 2.)  $V_{IN} \rightarrow V_{CC} \rightarrow V_{EN}$

#### Load Bleed (Quick Discharge)

The DML3010ALFDS device has an internal bleed discharge device, which is used to bleed the charge off from the load to ground after the MOSFET is disabled. The bleed discharge device is enabled whenever the MOSFET is disabled. The MOSFET and the bleed device are never concurrently active.

The BLEED pin must be connected to  $V_{OUT}$  either directly or through an external resistor,  $R_{EXT}$ . RexT should not exceed 1k $\Omega$  and can be used to increase the total bleed resistance.

To ensure that the power dissipated across  $R_{BLEED}$  is kept at a safe level, dissipated power of  $R_{BLEED}$  needs to be detail calculated. The maximum continuous power that can be dissipated across  $R_{BLEED}$  is 0.4W.  $R_{EXT}$  can be used to decrease the amount of power dissipated across  $R_{BLEED}$ .

#### Power Good

The DML3010ALFDS device has a power-good output (PG) that can be used to indicate when the gate of the MOSFET is driven high and the switch is on with the on-resistance close to its final value (full load ready). The PG pin is an active-high, open-drain output that requires an external pullup resistor,  $R_{PG}$ , greater than or equal to  $1k\Omega$  to an external voltage source,  $V_{TERM}$ , compatible with input levels of those devices connected to this pin.

Table 1 contains PG turn-on time values measured on a typical device. PG turn-on time shown below are valid for the power-up sequence 1.

Table 1. PG Turn-On Time

	Table III & Talli GII Tillio					
	$V_{CC} = 5V$ , $C_L = 0.1 \mu F$ , $R_L = 10 \Omega$ , $R_{PG} = 10 k \Omega$ , $+25 ^{\circ} C$					
	Vvin = 20V	V <sub>VIN</sub> = 12V	Vvin = 5V	V <sub>VIN</sub> = 3.3V	V <sub>VIN</sub> = 1.8V	
tpg on (ms)	1.16	0.88	0.66	0.6	0.55	

The power-good output can be used as the enable signal for other active-high devices in the system. This allows for guaranteed by design power sequencing and reduces the number of enable signals needed from the system controller. If the power-good feature is not used in the application, the PG pin should be tied to GND.



# **Application Information** (continued)

#### **Short-Circuit Protection**

The DML3010ALFDS device is equipped with short-circuit protection that is used to help protect the part and the system from a sudden high-current event, such as the output, Vout, being shorted to ground. This circuitry is only active when the gate of MOSFET is fully charged.

Once active, the circuitry monitors the difference in the voltage on the  $V_{IN}$  pin and the voltage on the BLEED pin. In order for the  $V_{OUT}$  voltage to be monitored through the BLEED pin, it is required that BLEED pin be connected to  $V_{OUT}$  either directly or through a resistor,  $R_{EXT}$ , which should not exceed  $1k\Omega$ . With the BLEED pin connected to  $V_{OUT}$ , the short-circuit protection is able to monitor the voltage drop across the MOSFET.

If the voltage drop across the MOSFET is greater than or equal to the short-circuit protection threshold voltage, the MOSFET is turned off immediately and the load bleed is activated. The part remains latched in this off state until EN is toggled or Vcc supply voltage is cycled, at which point the MOSFET will be turn-on delay and slew rate. The current through the MOSFET that will cause a short-circuit event can be calculated by dividing the short-circuit protection threshold by expected on-resistance of the MOSFET.

#### **Thermal Shutdown**

The DML3010ALFDS device is equipped with thermal shutdown protection for internally or externally generated excessive temperatures. This circuitry is disabled when EN is not active to reduce standby current. When an overtemperature condition is detected, the MOSFET is turned off immediately and the load bleed is active.

The part comes out of thermal shutdown when the junction temperature decreases to a safe operating temperature as dictated by the thermal hysteresis. Upon exiting a thermal shutdown state, and if EN remains active, the MOSFET will be turned on in a controlled fashion with the normal output turn-on delay and slew rate.

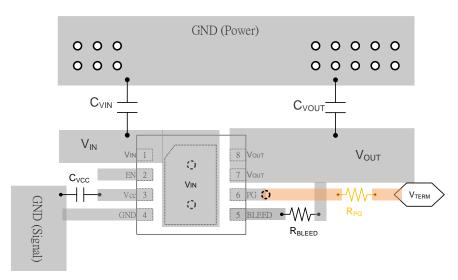
#### **Undervoltage Lockout**

The DML3010ALFDS device is equipped with undervoltage lockout protection. The DML3010ALFDS turns the MOSFET off and activates the load bleed when the input voltage Vcc is less than or equal to the undervoltage lockout threshold. This circuitry is disabled when EN is not active to reduce standby current.

If the V<sub>CC</sub> voltage rises above the undervoltage lockout threshold and EN remains active, the MOSFET will be turned on in a controlled fashion with the normal output turn-on delay and slew rate.

#### **PCB Layout Consideration**

- 1. Place the input/output capacitors C<sub>VIN</sub> and C<sub>VOUT</sub> as close as possible to the V<sub>IN</sub> and V<sub>OUT</sub> pins.
- 2. The power traces which are V<sub>IN</sub> trace, V<sub>OUT</sub> trace and GND trace should be short, wide and directly for minimizing parasitic inductance.
- 3. Place feedback resistance R<sub>BLEED</sub> as close as possible to BLEED pin.
- 4. Place Cvcc capacitor near the device pin.
- 5. Connect the signal ground to the GND pin, and keep a single connection from GND pin to the power ground behind the input or output capacitors.
- 6. For better power dissipation, via holes are recommended to connect the exposed pad's landing area to a large copper polygon on the other side of the printed circuit board. The copper polygons and exposed pad shall be connected to V<sub>IN</sub> pin on the printed circuit board.

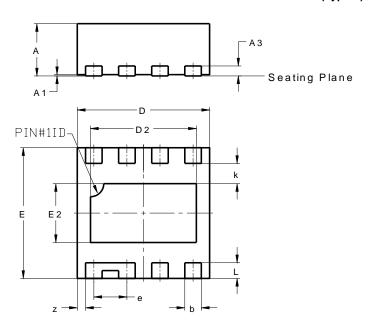




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## V-DFN2020-8 (Type N)

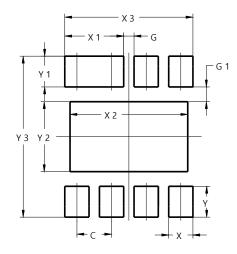


V-DFN2020-8 (Type N)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3			0.152		
b	0.20	0.30	0.25		
D	1.95	2.05	2.00		
D2	1.50	1.70	1.60		
Е	1.95	2.05	2.00		
E2	0.80	1.00	0.90		
е			0.50		
k		-	0.31		
١	0.19	0.29	0.24		
Z			0.125		
All	Dimens	ions in	mm		

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### V-DFN2020-8 (Type N)



Dimensions	Value		
	(in mm)		
С	0.500		
G	0.150		
G1	0.210		
X	0.350		
X1	0.850		
X2	1.700		
Х3	1.850		
Y	0.440		
Y1	0.440		
Y2	1.000		
Y3	2.300		



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